ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pan-American co	burn, Illinois, All rights res	served under both	This docume level parts, t	ent is a declaration the declaration end	n of the substance compasses all low	es within the manufactur ver level materials for wl	er listed item. N hich the manufa	Note: if the item is a acturer has engineer	n assembly with lower ing responsibility.		
2-21.1 IPC Web Site for Information on IPC-1752 Standard Form Type Distribute			*	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information							
Supplier Information											
ompany name* Company unique ID			Unique ID Authority			Response Date*					
onsemi								2025-06-07			
Contact Name	Title - Contact			Phone - Contact*			Email - Contact*				
Product-Env-Stewards	Product Enviro Compliance			NA			Product-Env-Stewards@onsemi.com				
Authorized Representative*	Title - Representative			Phone - Representative*			Email - Representative*				
Product-Env-Stewards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr Item	n Number Mfr Item	Mfr Item Name		Effective Date	Version	Manufacturing Site	Weigh	nt* UOM	Unit Type		
FAN535	526UC64X TBD_25c	h		2025-06-07		PBB	3.3330	069 mg	Each		
Manufacturing Proccess Information											
Terminal Plating / Grid Array Material	Ferminal Base Alloy	J-STD-020 MS	L Rating	Peak Proces	s Body Temperat	ture Max Time at Peak	Temperature	Number of Reflow	Cycles		
SnAgCu (CU Alloy	1		260	С	30	seconds	3			
Comments											
evel 1 - maximum time at peak temperature during so	Idering is 10-30 seconds										
For more information regarding material composition	please refer to page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth	
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the
Supplier Digital Signature Ra	stislav Drska	Le			

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Backside Protection Film 0.1	0.103505	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.0217	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0019	mg
			Supplier	Silica (SiO2)	14464-46-1		0.0583	mg
			Supplier	2,4,6-Tris[Bis(Methoxymethyl)Amino]- 1,3,5-Triazine	3089-11-0		0.0217	mg
Die 2.3	2.31625	mg	Supplier	Silicon (Si)	7440-21-3		2.2956	mg
			Supplier	Aluminum (Al)	7429-90-5		0.0206	mg
Solder Ball	0.912574	mg	Supplier	Silver (Ag)	7440-22-4		0.0365	mg
			Supplier	Tin (Sn)	7440-31-5		0.8715	mg
			Supplier	Copper (Cu)	7440-50-8		0.0046	mg
Under Bump Metal	7.4E-4	mg	Supplier	Titanium (Ti)	7440-32-6		0	mg
			В	Nickel (Ni)	7440-02-0		0.0005	mg
			Supplier	Gold (Au)	7440-57-5		0.0002	mg
			Supplier	Copper (Cu)	7440-50-8		0	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 signa range of distribution unless otherwise noted).